

## Small signal Schottky diode

#### **Features**

- Low leakage current losses
- Negligible switching losses
- Low forward and reverse recovery times
- Extremely fast switching
- Surface mount device
- Low capacitance diode

### **Description**

The BAT48 series uses 40 V Schottky barrier diodes packaged in SOD-123, SOD-323 or DO-35. This series is general purpose and features very low turn-on voltage and fast switching.

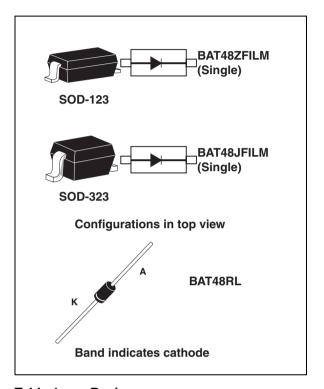


Table 1. Device summary

Symbol	Value
I <sub>F</sub>	350 mA
V <sub>RRM</sub>	40 V
C (typ)	18 pF
T <sub>j</sub> (max)	150 °C

Characteristics BAT48

### 1 Characteristics

Table 2. Absolute ratings (limiting values at  $T_j = 25$  °C, unless otherwise specified)

Symbol	Par	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage	)		40	V
I <sub>F</sub>	Continuous forward current			350	mA
1	Surge non repetitive forward	$t_{p} = 10 \text{ ms}$	SOD-123, SOD-323	2	Α
I <sub>FSM</sub>	current	sinusoidal	DO-35	7.5	A
T <sub>stg</sub>	Storage temperature range			-65 to +150	°C
т.	Maximum operating junction te	mperature	SOD-123, SOD-323	-40 to +150	°C
Tj	range		DO-35	-40 to +125	O
	T <sub>L</sub> Maximum temperature for soldering during 10 s		SOD-123, SOD-323	260	
TL			DO-35 at 4 mm from case	230	°C

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit	
В	Junction to ambient <sup>(1)</sup>		SOD-123	500	°C/W
R <sub>th(j-a)</sub>	a) Junction to ambient		SOD-323	550	C/VV
R <sub>th(j-l)</sub>	Junction to lead <sup>(2)</sup>		DO-35	300	°C/W

<sup>1.</sup> Epoxy printed circuit board with recommended pad layout

<sup>2.</sup> On infinite heatsink with 4 mm lead length

BAT48 Characteristics

Table 4. Static electrical characteristics

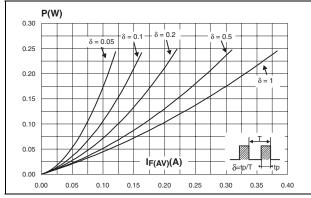
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
$V_{BR}$	Breakdown reverse voltage	T <sub>j</sub> = 25 °C	I <sub>r</sub> = 25 μA	40			٧
	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current		V <sub>R</sub> = 1.5 V			1	
		T <sub>i</sub> = 25 °C	V <sub>R</sub> = 10 V			2	
		$I_j = 25$ C	V <sub>R</sub> = 20 V			5	
ı (1)			V <sub>R</sub> = 40 V			25	μА
'R` ′		T <sub>j</sub> = 60 °C	V <sub>R</sub> = 1.5 V			10	
			V <sub>R</sub> = 10 V			15	
			V <sub>R</sub> = 20 V			25	
			V <sub>R</sub> = 40 V			50	
			I <sub>F</sub> = 0.1 mA			0.25	
			I <sub>F</sub> = 1 mA			0.3	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	Forward valtage drap	T 05 °C	I <sub>F</sub> = 10 mA			0.4	V
	''I	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 50 mA			0.5	V
			I <sub>F</sub> = 200 mA			0.75	
			I <sub>F</sub> = 500 mA			0.9	

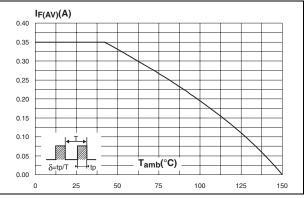
<sup>1.</sup> Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Diode capacitance	V <sub>R</sub> = 0 V, F = 1 MHz		30		рF
		V <sub>R</sub> = 1 V, F = 1 MHz		18		рг

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature ( $\delta$  = 1)





<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2 %

Characteristics BAT48

Figure 3. Reverse leakage current versus reverse applied voltage (typical values)

I<sub>R</sub>(μA)

1.E+03

1.E+02

1.E+01

Figure 4. Reverse leakage current versus junction temperature (typical values)

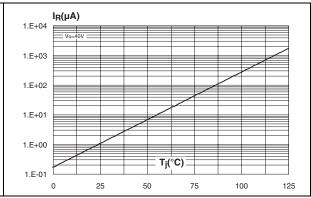
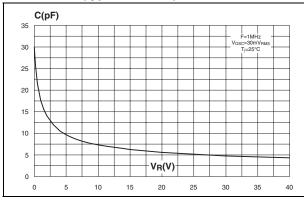


Figure 5. Junction capacitance versus reverse applied voltage (typical values)

Figure 6. Forward voltage drop versus forward current (typical values)



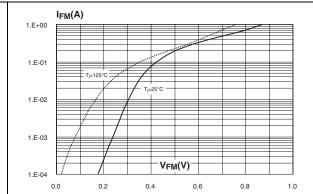


Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (SOD-323)

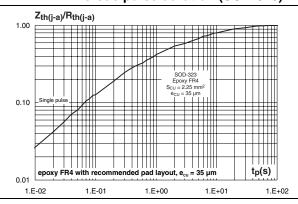
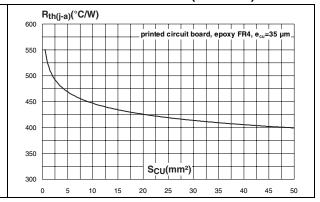


Figure 8. Thermal resistance junction to ambient versus copper surface under each lead (SOD-323)

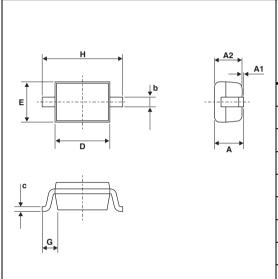


## 2 Package information

- Epoxy meets UL94,V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. SOD-123 dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
Α		1.45		0.057		
A1	0	0.1	0	0.004		
A2	0.85	1.35	0.033	0.053		
b	0.55	Тур.	0.022 Typ.			
С	0.15	Тур.	0.039	Тур.		
D	2.55	2.85	0.1	0.112		
Е	1.4	1.7	0.055	0.067		
G	0.25		0.01			
Н	3.55	3.75	0.14	0.148		

Figure 9. SOD-123 footprint, dimensions in mm (inches)

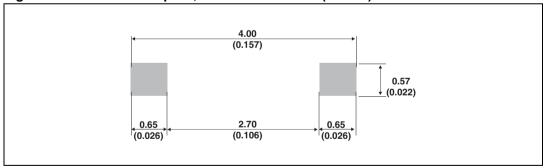
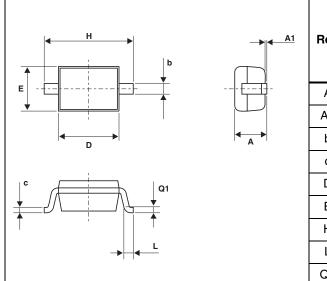


Table 7. SOD-323 dimensions



	Dimensions					
Ref.	Millimeters		Inc	nes		
	Min.	Max. Min.		Max.		
Α		1.17		0.046		
A1	0	0.1	0	0.004		
b	0.25	0.44	0.01	0.017		
С	0.1	0.25	0.004	0.01		
D	1.52	1.8	0.06	0.071		
Е	1.11	1.45	0.044	0.057		
Н	2.3	2.7	0.09	0.106		
L	0.1	0.46	0.004	0.02		
Q1	0.1	0.41	0.004	0.016		

Figure 10. SOD-323 footprint (dimensions in mm)

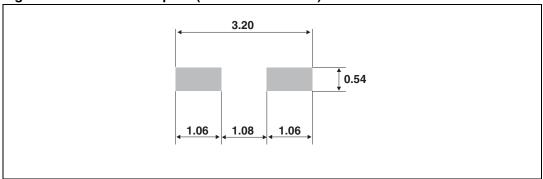
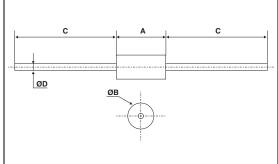


Table 8. DO-35 dimensions



	Dimensions					
Ref.	Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.		
Α	3.05	4.50	0.120	0.177		
В	1.53	2.00	0.060 0.079			
С	12.7		0.500			
D	0.458	0.558	0.018	0.022		

# 3 Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
BAT48ZFILM	Z48	SOD-123 Single	10 mg	3000	Tape and reel
BAT48JFILM	48	SOD-323 Single	5 mg	3000	Tape and reel
BAT48RL	BAT48	DO-35	15 mg	4000	Tape and reel

# 4 Revision history

Table 10. Document revision history

Date	Revision	Changes		
08-Aug-2006	1	Initial release.		
07-Jul-2011	2	Updated package information for SOD-123. Added DO-35 package.		

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